

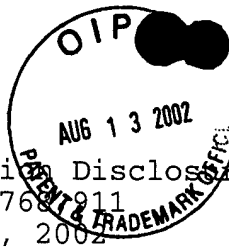
Information Disclosure Statement
USSN 09/768,911
August 9, 2002
Page 3

Form PTO-1449 (Modified)	ATTY DOCKET NO. B-3962 618027-2	U.S. SERIAL NO. 09/768,911
LIST OF PATENTS AND PUBLICATIONS STATEMENT	APPLICANT(S) Lap-Wai CHOW, et al.	
	FILING DATE January 24, 2001	GROUP 2811 2827

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David H. Farnick 12/9/2



Information Disclosure Statement
USSN 09/768,911
August 9, 2002
Page 4

RECEIVED
AUG 20 2002
TECHNOLOGY CENTER 2800

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Smith, Jan 12/9/12



Information Disclosure Statement
USSN 09/768,911
August 9, 2002
Page 5

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Jan-H. Javade 12/9/2



Information Disclosure Statement
USSN 09/768,911
August 9, 2002
Page 6

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Information Disclosure Statement
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Page 7

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